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# 74HC4040-Q100; 74HCT4040-Q100

### 12-stage binary ripple counter

Rev. 1 — 24 March 2014

Product data sheet

### 1. General description

The 74HC4040-Q100; 74HCT4040-Q100 is a 12-stage binary ripple counter with a clock input  $(\overline{CP})$ , an overriding asynchronous master reset input (MR) and twelve parallel outputs (Q0 to Q11). The counter advances on the HIGH-to-LOW transition of  $\overline{CP}$ . A HIGH on MR clears all counter stages and forces all outputs LOW, independent of the state of  $\overline{CP}$ . Each counter stage is a static toggle flip-flop. Inputs include clamp diodes that enable the use of current limiting resistors to interface inputs to voltages in excess of  $V_{CC}$ .

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

#### 2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
  - ◆ Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Complies with JEDEC standard no. 7A
- Input levels:
  - ◆ For 74HC4040-Q100: CMOS level
  - ◆ For 74HCT4040-Q100: TTL level
- ESD protection:
  - MIL-STD-883, method 3015 exceeds 2000 V
  - HBM JESD22-A114F exceeds 2000 V
  - ♦ MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)
- Multiple package options

### 3. Applications

- Frequency dividing circuits
- Time delay circuits
- Control counters

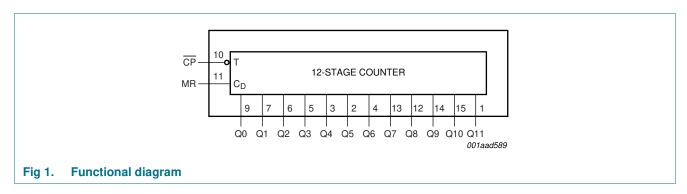


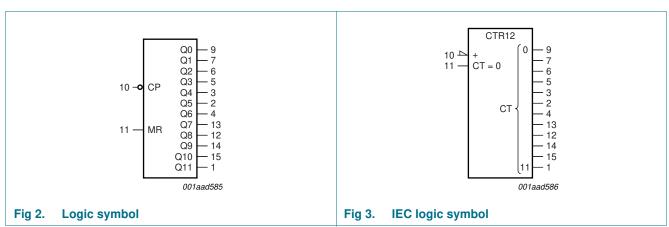
### 4. Ordering information

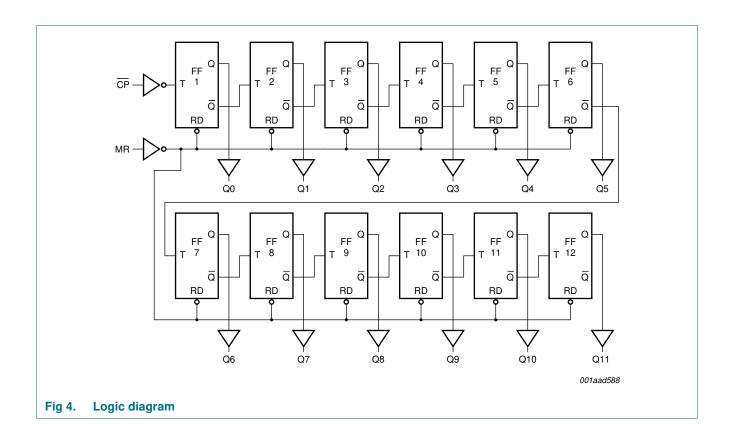
Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74HC4040D-Q100	-40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body	SOT109-1
74HCT4040D-Q100			width 3.9 mm	
74HC4040DB-Q100	-40 °C to +125 °C	SSOP16	plastic shrink small outline package; 16 leads;	SOT338-1
74HCT4040DB-Q100			body width 5.3 mm	
74HC4040PW-Q100	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16	SOT403-1
74HCT4040PW-Q100			leads; body width 4.4 mm	
74HC4040BQ-Q100	–40 °C to +125 °C	DHVQFN16	plastic dual in-line compatible thermal enhanced	SOT763-1
74HCT4040BQ-Q100			very thin quad flat package; no leads; 16 terminals; body $2.5 \times 3.5 \times 0.85$ mm	

### 5. Functional diagram

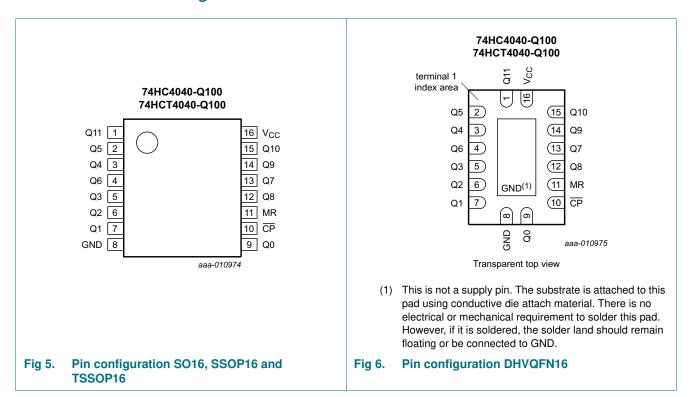






### 6. Pinning information

#### 6.1 Pinning



#### 6.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
Q11	1	output 11
Q5	2	output 5
Q4	3	output 4
Q6	4	output 6
Q3	5	output 3
Q2	6	output 2
Q1	7	output 1
GND	8	ground (0 V)
Q0	9	output 0
CP	10	clock input (HIGH-to-LOW, edge-triggered)
MR	11	master reset input (active HIGH)
Q8	12	output 8
Q7	13	output 7
Q9	14	output 9
Q10	15	output 10
V <sub>CC</sub>	16	positive supply voltage

74HC\_HCT4040\_Q100

### 7. Functional description

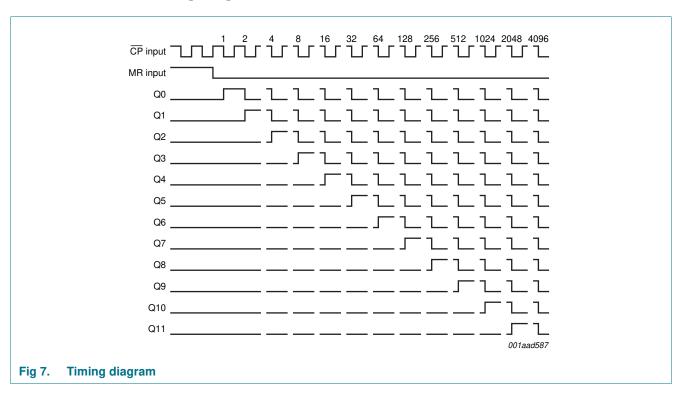
#### 7.1 Function table

Table 3. Function table

Input CP		Output
СР	MR	Q0 to Q11
$\uparrow$	L	no change
$\downarrow$	L	count
X	Н	L

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; ↑ = LOW-to-HIGH clock transition; ↓ = HIGH-to-LOW clock transition.

#### 7.2 Timing diagram



### **Limiting values**

Table 4. **Limiting values** 

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	I	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-	-0.5	+7	V
I <sub>IK</sub>	input clamping current	$V_I < -0.5 \text{ V or VI} > V_{CC} + 0.5 \text{ V}$	-	-	±20	mA
I <sub>OK</sub>	output clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$	-	-	±20	mA
Io	output current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$	-	-	±25	mA
Icc	supply current		-	-	±50	mA
I <sub>GND</sub>	ground current		-	-	±50	mA
T <sub>stg</sub>	storage temperature		-	-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40  ^{\circ}\text{C} \text{ to } +125  ^{\circ}\text{C}$	[1]	-	500	mW

<sup>[1]</sup> For SO16, SSOP16, TSSOP16 and DHVQFN16 packages, above 70 °C, Ptot derates linearly with 8 mW/K.

### **Recommended operating conditions**

**Recommended operating conditions** 

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	ns 74HC4040-Q100				74HCT4040-Q100				
			Min	Тур	Max	Min	Тур	Max	V V V °C ns/V ns/V		
V <sub>CC</sub>	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V		
VI	input voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V		
Vo	output voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V		
T <sub>amb</sub>	ambient temperature		-40	+25	+125	-40	+25	+125	°C		
Δt/ΔV	input transition rise and fall rate	$V_{CC} = 2.0 \text{ V}$	-	-	625	-	-	-	ns/V		
		$V_{CC} = 4.5 \text{ V}$	-	1.67	139	-	1.67	139	ns/V		
		$V_{CC} = 6.0 \text{ V}$	-	-	83	-	-	-	ns/V		

### 10. Static characteristics

#### Table 6. **Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		-40 °C to	+85 °C	–40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC404	40-Q100		<u>'</u>							
V <sub>IH</sub>	HIGH-level	$V_{CC} = 2.0 \text{ V}$	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	$V_{CC} = 4.5 \text{ V}$	3.15	2.4	-	3.15	-	3.15	-	V
		$V_{CC} = 6.0 \text{ V}$	4.2	3.2	-	4.2	-	4.2	-	V
$V_{IL}$	LOW-level	V <sub>CC</sub> = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	$V_{CC} = 4.5 \text{ V}$	-	2.1	1.35	-	1.35	-	1.35	V
		$V_{CC} = 6.0 \text{ V}$	-	2.8	1.8	-	1.8	-	1.8	٧

 Table 6.
 Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol V <sub>OH</sub>	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	–40 °C t	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
V <sub>OH</sub>	HIGH-level	$V_I = V_{IH}$ or $V_{IL}$								
	output voltage	$I_O = -20 \mu A$ ; $V_{CC} = 2.0 \text{ V}$	1.9	2.0	-	1.9	-	1.9	-	٧
		$I_O = -20 \mu A$ ; $V_{CC} = 4.5 V$	4.4	4.5	-	4.4	-	4.4	-	٧
		$I_{O} = -20 \mu A; V_{CC} = 6.0 V$	5.9	6.0	-	5.9	-	5.9	-	٧
		$I_O = -4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.98	4.32	-	3.84	-	3.7	-	٧
		$I_{O} = -5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.48	5.81	-	5.34	-	5.2	-	٧
$V_{OL}$	LOW-level	$V_I = V_{IH}$ or $V_{IL}$								
	output voltage	$I_O = 20 \mu A; V_{CC} = 2.0 \text{ V}$	-	0	0.1	-	0.1	-	0.1	٧
		$I_O = 20 \mu A; V_{CC} = 4.5 V$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 20 \mu A; V_{CC} = 6.0 V$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.15	0.26	-	0.33	-	0.4	V
		$I_O = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.26	-	0.33	-	0.4	V
I <sub>I</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±0.1	-	±1.0	-	±1.0	μΑ
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0$ V	-	-	8.0	-	80	-	160	μΑ
Cı	input capacitance		-	3.5	-					pF
74HCT4	040-Q100				1					
$V_{IH}$	HIGH-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
$V_{IL}$	LOW-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	-	1.2	8.0	-	0.8	-	0.8	V
V <sub>OH</sub>	HIGH-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$								
	output voltage	$I_{O} = -20 \mu A$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_O = -4 \text{ mA}$	3.98	4.32	-	3.84	-	3.7	-	V
$V_{OL}$	LOW-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$								
	output voltage	I <sub>O</sub> = 20 μA	-	0	0.1	-	0.1	-	0.1	٧
		$I_O = 4.0 \text{ mA}$	-	0.15	0.26	-	0.33	-	0.4	٧
l <sub>l</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±0.1	-	±1.0	-	±1.0	μΑ
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5$ V	-	-	8.0	-	80	-	160	μΑ
Δl <sub>CC</sub>	additional supply current	per input pin; $V_I = V_{CC} - 2.1 \text{ V; } I_O = 0 \text{ A;}$ other inputs at $V_{CC}$ or GND; $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$								
		pin CP	-	85	306	-	383	-	417	μΑ
		pin MR	-	110	396	-	495	-	539	μΑ
Cı	input capacitance		-	3.5	-	-	-	-	-	pF

### 11. Dynamic characteristics

Table 7. Dynamic characteristics

GND (ground = 0 V);  $C_L$  = 50 pF unless otherwise specified; for test circuit see Figure 9.

74HC40	Parameter	Conditions		25 °C	;	-40 °C t	o +85 °C	-40 °C t	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC404	I0-Q100									
t <sub>pd</sub>	propagation	CP to Q0; see Figure 8								
74HC4040 tpd pi di tPHL H pi di tt tr  tt tr  trec re	delay	V <sub>CC</sub> = 2.0 V	-	47	150	-	190	-	225	ns
		V <sub>CC</sub> = 4.5 V	-	17	30	-	38	-	45	ns
		V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF	-	14	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	14	26	-	33	-	38	ns
		Qn to Qn+1; see Figure 8								
		V <sub>CC</sub> = 2.0 V	-	28	100	-	125	-	150	ns
		V <sub>CC</sub> = 4.5 V	-	10	20	-	25	-	30	ns
		V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF	-	8	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	8	17	-	21	-	26	ns
<sup>‡</sup> PHL	HIGH to LOW	MR to Qn; see Figure 8								
	propagation	V <sub>CC</sub> = 2.0 V	-	61	185	-	230	-	280	ns
	delay	V <sub>CC</sub> = 4.5 V	-	22	37	-	46	-	56	ns
		V <sub>CC</sub> = 6.0 V	-	18	31	-	39	-	48	ns
ŧ	transition time	Qn; see Figure 8 [2]								
		V <sub>CC</sub> = 2.0 V	-	19	75	-	95	-	110	ns
		V <sub>CC</sub> = 4.5 V	-	7	15	-	19	-	22	ns
		V <sub>CC</sub> = 6.0 V	-	6	13	-	16	-	19	ns
t <sub>W</sub>	pulse width	CP input, HIGH or LOW; see Figure 8								
		V <sub>CC</sub> = 2.0 V	80	14	-	100	-	120	-	ns
		V <sub>CC</sub> = 4.5 V	16	5	-	20	-	24	-	ns
		V <sub>CC</sub> = 6.0 V	14	4	-	17	-	20	-	ns
		MR input, HIGH; see Figure 8								
		V <sub>CC</sub> = 2.0 V	80	22	-	100	-	120	-	ns
		V <sub>CC</sub> = 4.5 V	16	8	-	20	-	24	-	ns
		V <sub>CC</sub> = 6.0 V	14	6	-	17	-	20	-	ns
rec	recovery time	MR to CP; see Figure 8								
		V <sub>CC</sub> = 2.0 V	50	8	-	65	-	75	-	ns
		V <sub>CC</sub> = 4.5 V	10	3	-	13	-	15	-	ns
		V <sub>CC</sub> = 6.0 V	9	2	-	11	-	13	-	ns
max	maximum	CP input; see Figure 8								
	frequency	V <sub>CC</sub> = 2.0 V	6	27	-	4.8	-	4	-	МН
fr		V <sub>CC</sub> = 4.5 V	30	82	-	24	-	20	-	МН
		V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF	-	90	-	-	-	-	-	MH:
		V <sub>CC</sub> = 6.0 V	35	98	_	28	_	24	_	MH

74HC\_HCT4040\_Q100

 Table 7.
 Dynamic characteristics ...continued

GND (ground = 0 V);  $C_L$  = 50 pF unless otherwise specified; for test circuit see Figure 9.

Symbol	Parameter	Conditions		25 °C		-40 °C	to +85 °C	–40 °C t	o +125 °C	Unit
			Mi	n Typ	Max	Min	Max	Min	Max	
$C_PD$	power dissipation capacitance	$V_I = GND \text{ to } V_{CC}$	3] -	- 20	0 -	-	-	-	-	pF
74HCT40	)40-Q100		·	•						
t <sub>pd</sub>	propagation	CP to Q0; see Figure 8	1]							
	delay	V <sub>CC</sub> = 4.5 V	-	19	40	-	50	-	60	ns
		V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF	-	16	-	-	-	-	-	ns
		Qn to Qn+1; see Figure 8								
		V <sub>CC</sub> = 4.5 V	-	10	20	-	25	-	30	ns
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$	-	8	-	-	-	-	-	ns
t <sub>PHL</sub>	HIGH to LOW	MR to Qn; see Figure 8								
	propagation delay	V <sub>CC</sub> = 4.5 V	-	23	45	-	56	-	68	ns
t <sub>t</sub>	transition time	Qn; see Figure 8	<u>2]</u>							
		V <sub>CC</sub> = 4.5 V	-	7	15	-	19	-	22	ns
t <sub>W</sub>	pulse width	CP input, HIGH or LOW; see Figure 8								
		V <sub>CC</sub> = 4.5 V	16	7	-	20	-	24	-	ns
		MR input, HIGH; see Figure 8								
		V <sub>CC</sub> = 4.5 V	16	6	-	20	-	24	-	ns
t <sub>rec</sub>	recovery time	MR to CP; see Figure 8								
		V <sub>CC</sub> = 4.5 V	10	2	-	13	-	15	-	ns
f <sub>max</sub>	maximum	CP input; see Figure 8								
	frequency	V <sub>CC</sub> = 4.5 V	30	72	-	24	-	20	-	MHz
		V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF	-	79	-	-	-	-	-	MHz
C <sub>PD</sub>	power dissipation capacitance	$V_I = GND \text{ to } V_{CC}$	3] -	20	-	-	-	-	-	pF

- [1]  $t_{pd}$  is the same as  $t_{PHL}$ ,  $t_{PLH}$ .
- $[2] \quad t_t \text{ is the same as } t_{THL}, \, t_{TLH}.$
- [3]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$  where:

 $f_i$  = input frequency in MHz;

f<sub>o</sub> = output frequency in MHz;

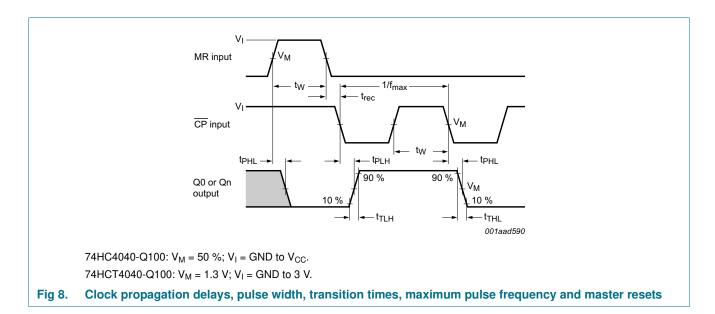
C<sub>L</sub> = output load capacitance in pF;

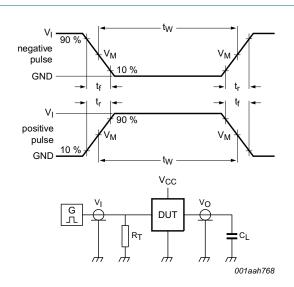
 $V_{CC}$  = supply voltage in V;

N = number of inputs switching;

 $\sum (C_L \times V_{CC}^2 \times f_o)$  = sum of outputs.

### 12. Waveform and test circuit





Test data is given in Table 8.

Definitions test circuit:

 $R_T$  = termination resistance should be equal to output impedance  $Z_0$  of the pulse generator.

 $\ensuremath{C_L}$  = load capacitance including jig and probe capacitance.

Fig 9. Test circuit for measuring switching times

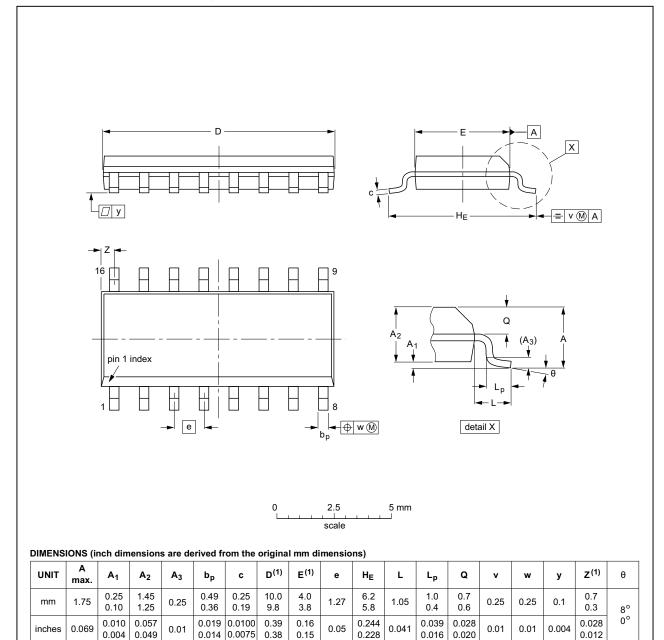
Table 8. Test data

Туре	Input		Load	Test
	VI	t <sub>r</sub> , t <sub>f</sub>	CL	
74HC4040-Q100	V <sub>CC</sub>	6.0 ns	15 pF, 50 pF	t <sub>PLH</sub> , t <sub>PHL</sub>
74HCT4040-Q100	3.0 V	6.0 ns	15 pF, 50 pF	t <sub>PLH</sub> , t <sub>PHL</sub>

### 13. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



#### Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

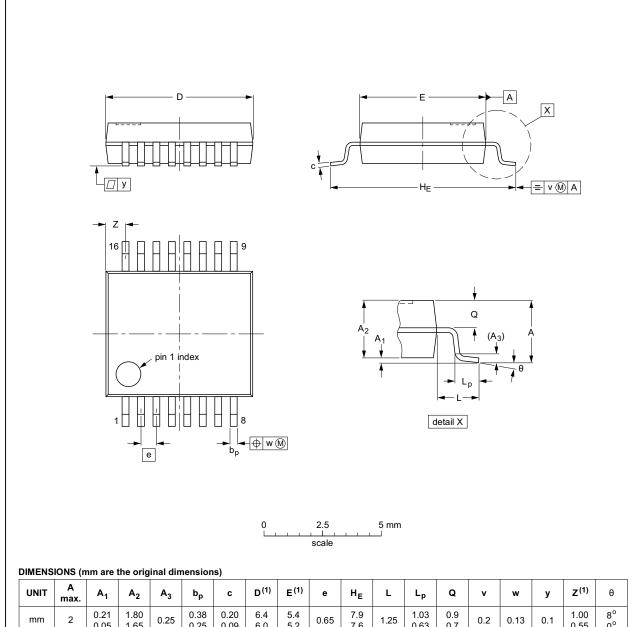
OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT109-1	076E07	MS-012			<del>99-12-27</del> 03-02-19

Fig 10. Package outline SOT109-1 (SO16)

74HC\_HCT4040\_Q100

SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm

SOT338-1



_							-,												
	UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
	mm	2	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.00 0.55	8° 0°

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT338-1		MO-150				<del>99-12-27</del> 03-02-19	

Fig 11. Package outline SOT338-1 (SSOP16)

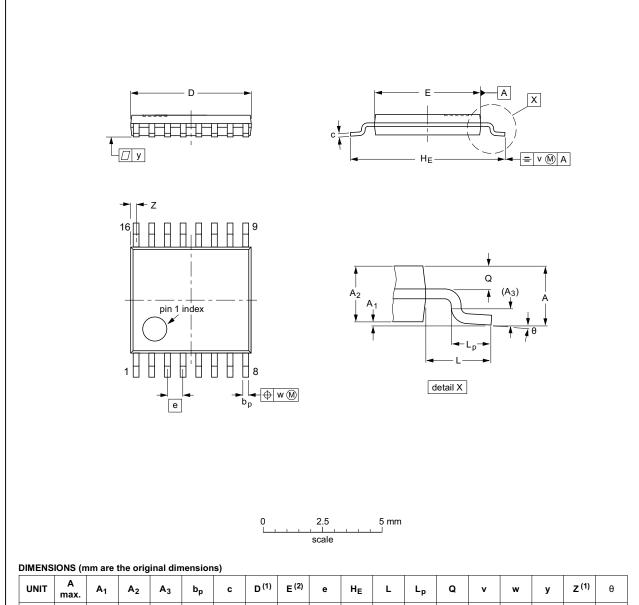
74HC\_HCT4040\_Q100

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13 of 19

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



UNI	IT	A max.	<b>A</b> <sub>1</sub>	A <sub>2</sub>	<b>A</b> <sub>3</sub>	b <sub>p</sub>	С	D <sup>(1)</sup>	E (2)	е	HE	L	Lp	Q	٧	w	у	Z <sup>(1)</sup>	θ
mn	n	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.40 0.06	8° 0°

#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT403-1		MO-153				<del>99-12-27</del> 03-02-18	

Fig 12. Package outline SOT403-1 (TSSOP16)

74HC\_HCT4040\_Q100

DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

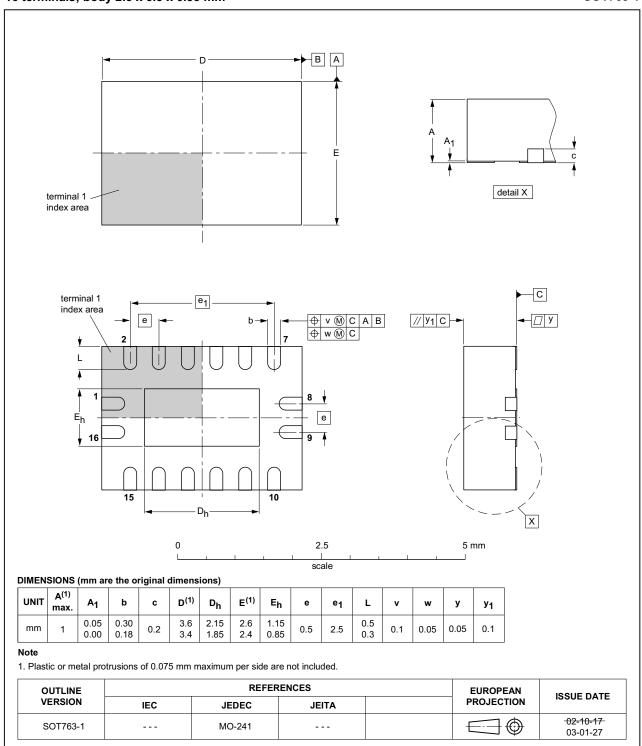


Fig 13. Package outline SOT763-1 (DHVQFN16)

74HC\_HCT4040\_Q100

### 14. Abbreviations

#### Table 9. Abbreviations

Acronym	Description
CMOS	Complementary Metal Oxide Semiconductor
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MIL	Military
TTL	Transistor-Transistor Logic

## 15. Revision history

#### Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT4040_Q100 v.1	20140324	Product data sheet	-	-

### 16. Legal information

#### 16.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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# 74HC4040-Q100; 74HCT4040-Q100

12-stage binary ripple counter

### 18. Contents

1	General description
2	Features and benefits
3	Applications
4	Ordering information 2
5	Functional diagram 2
6	Pinning information 4
6.1	Pinning
6.2	Pin description 4
7	Functional description 5
7.1	Function table 5
7.2	Timing diagram 5
8	Limiting values 6
9	Recommended operating conditions 6
10	Static characteristics 6
11	Dynamic characteristics 8
12	Waveform and test circuit 10
13	Package outline
14	Abbreviations
15	Revision history
16	Legal information
16.1	Data sheet status
16.2	Definitions
16.3	Disclaimers
16.4	Trademarks18
17	Contact information 18
18	Contents